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APPLICANTS INFORMATION DISCLOSURE STATEMENT

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Applicant: Brodsky

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Group: "

2833

## U.S. PATENT DOCUMENTS

Initial*		Document No.	Date	Name	Class	Subcl.	Filing Date
B.	AA	4,988,306	01/29/91	Hopfer, III et al	439	66	05/16/89
B	AB	5,122,067	06/16/92	Sunne	439	91	05/23/91
O.	AC	5,599,193	02/04/97	Crotzer	. 439	66	08/23/94
(h	AD	5,650,919	07/22/97	Loh et al	361	779	02/21/96
18	AE	5,720,630	02/24/98	Richmond et al	439	591	02/26/96
19	AF	5,886,590	03/23/99	Quan et al	333	33	09/04/97
G.	AG	5,899,757	05/04/99	Neidich et al	439	67	11/03/97
1,2	AH	5,939,783	08/17/99	Laine et al	257	702	05/05/98
J	AI	5,940,278	08/17/99	Schumacher	361	769	04/30/97
12	ΑJ	5,969,953	10/19/99	Purdom et al	361	790	09/23/98
12	AK	6,036,502	03/14/00	Neidich et al	439	67	01/28/99
			FO	REIGN REFERENCES			
	AL						
	AM				1		

	AL			
1 1	AM			
I	AN			
ŀ	AO			

## OTHER DOCUMENTS

	AO	IBM Technical Disclosure Bulletin, January, 1993, "Button Contacts for Probe Card Applications", pp. 186-187					
le	ΑP	IBM Technical Disclosure Bulletin, March, 1991, "Pluggable/Removable Cube of Chips Packaging Method", pp. 459-460					
	AQ						
	AR						
	AS						
	AT						
Examiner:	1	1 LUMMS Date Considered: 4125/05					

<sup>\*</sup>EXAMINER: Initial if reference considered, whether or not citation is in conformation with MPEP 609; draw line through citation if in conformance and not considered. Include copy of this form with next communication to applicant.